



Parameters	Ratings	Units
Blocking Voltage	600	V_P
Load Current	100	mA
Input Control Current	2	mA
Max On-resistance	50	Ω

Features

- Blocking Voltage: 600V
- Low Input Control Current: 2mA
- 4000V_{rms} Input/Output Isolation
- Small 6-Pin Package
- Low Drive Power Requirements (TTL/CMOS Compatible)
- No Moving Parts
- High Reliability
- Arc-Free With No Snubbing Circuits
- FCC Compatible
- VDE Compatible
- No EMI/RFI Generation
- Machine Insertable, Wave Solderable

Applications

- Instrumentation
 - Multiplexers
 - Data Acquisition
 - Electronic Switching
 - I/O Subsystems
 - Meters (Watt-Hour, Water, Gas)
- Medical Equipment—Patient/Equipment Isolation
- Security
- Aerospace
- Industrial Controls

Description

The PLA143 is a single-pole, normally open (1-Form-A) solid state relay that uses optically coupled MOSFET technology to provide an enhanced input to output isolation of 4000V_{rms}. The efficient MOSFET switches and photovoltaic die use Clare's patented OptoMOS architecture. The optically coupled output is controlled by a highly efficient GaAlAs infrared LED.

The PLA143 can be used to replace mechanical relays, and offers the superior reliability associated with semiconductor devices. Because it has no moving parts, it offers faster, bounce-free switching in a more compact surface mount or thru-hole package.

Approvals

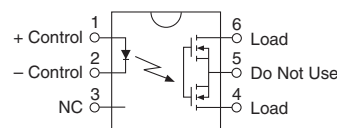
- UL Recognized Component: File E76270
- CSA Certified Component: Certificate 1175739
- EN/IEC 60950-1 Certified Component:
TUV Certificate B 09 07 49410 004

Ordering Information

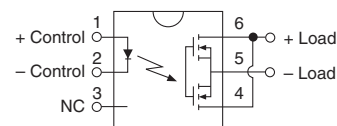
Part #	Description
PLA143	6-Pin DIP (50/Tube)
PLA143S	6-Pin Surface Mount (50/Tube)
PLA143STR	6-Pin Surface Mount (1000/Reel)

Pin Configuration

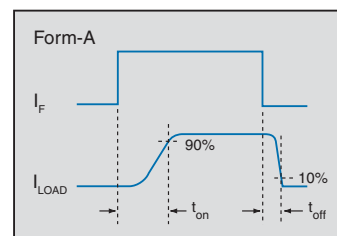
AC/DC Configuration



DC Only Configuration



Switching Characteristics of Normally Open Devices



Absolute Maximum Ratings @ 25°C

Parameter	Ratings	Units
Peak Blocking Voltage	600	V _P
Reverse Input Voltage	5	V
Input Control Current	50	mA
Peak (10ms)	1	A
Input Power Dissipation ¹	100	mW
Total Package Dissipation ²	800	mW
Isolation Voltage, Input to Output	4000	V _{rms}
Operational Temperature	-40 to +85	°C
Storage Temperature	-40 to +125	°C

¹ Derate linearly 1.33 mW / °C

² Derate linearly 6.67 mW / °C

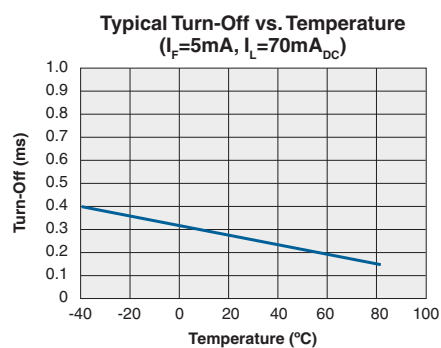
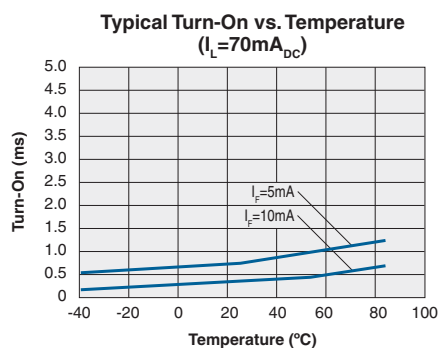
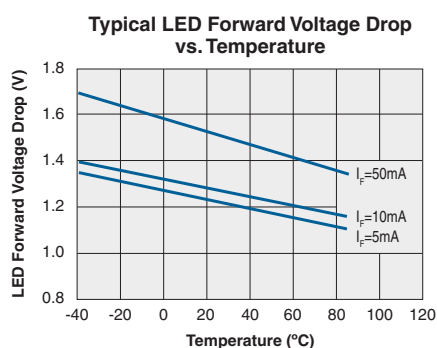
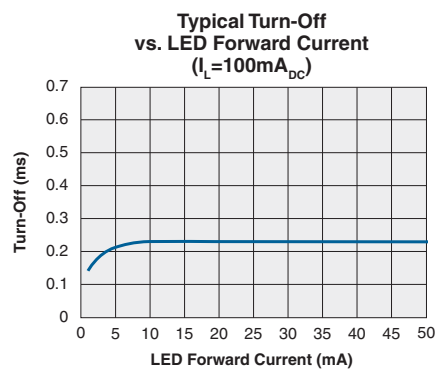
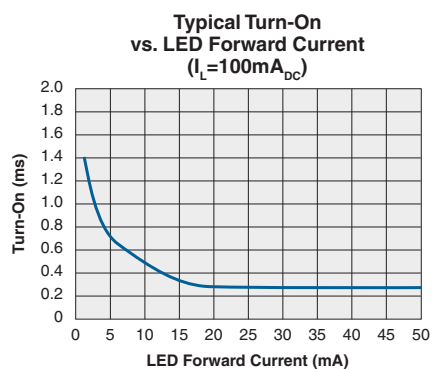
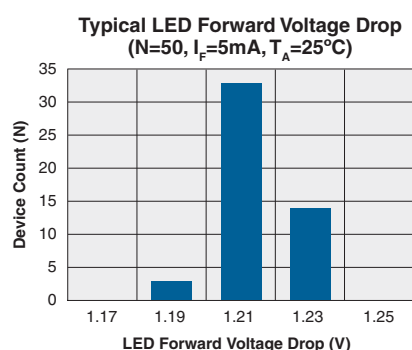
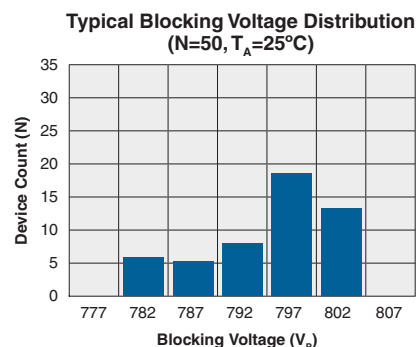
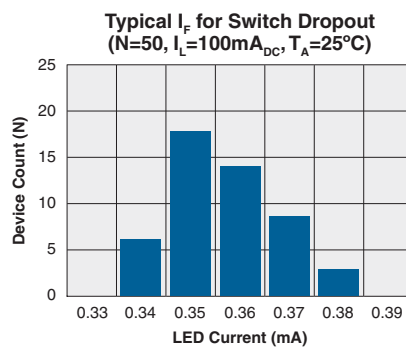
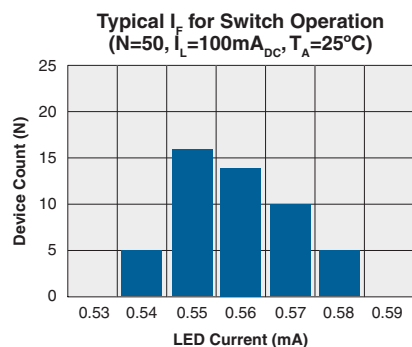
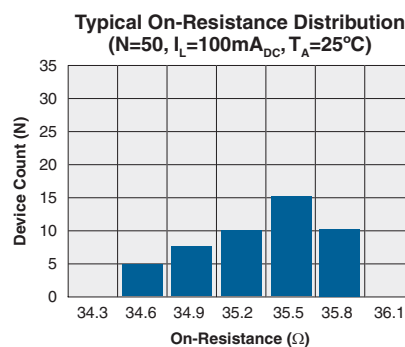
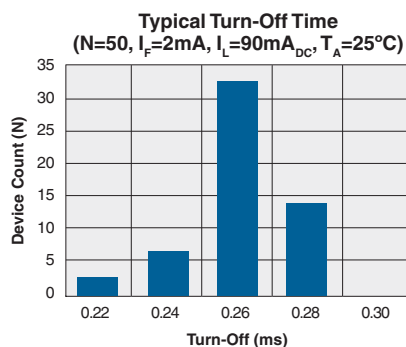
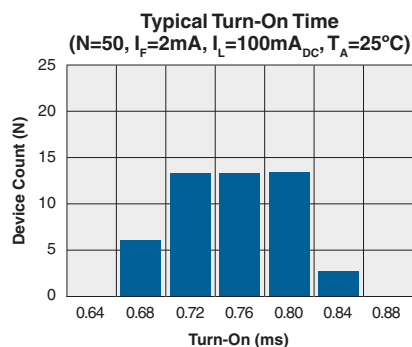
Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.

Electrical Characteristics @ 25°C

Parameters	Conditions	Symbol	Min	Typ	Max	Units
Output Characteristics						
Load Current, Continuous	-	I _L	-	-	100	mA
AC/DC Configuration			-	-	170	
DC Configuration	-					
Peak Load Current	t=10ms	I _{LPK}	-	-	350	mA
On-Resistance ¹	I _L =100mA	R _{ON}	-	-	50	Ω
AC/DC Configuration			-	-	14	
DC Configuration	I _L =170mA					
Off-State Leakage Current	V _L =600V _P	I _{LEAK}	-	-	1	μA
Switching Speeds	I _F =5mA, V _L =10V	t _{on}	-	-	5	ms
Turn-On			-	-	5	
Turn-Off		t _{off}	-	-	5	
Output Capacitance	V _L =50V, f=1MHz	C _{OUT}	-	50	-	pF
Input Characteristics						
Input Control Current	I _L =90mA	I _F	-	-	2	mA
Input Dropout Current	-	I _F	0.2	0.35	-	mA
Input Voltage Drop	I _F =5mA	V _F	0.9	1.2	1.4	V
Reverse Input Current	V _R =5V	I _R	-	-	10	μA
Common Characteristics						
Input to Output Capacitance	-	C _{I/O}	-	3	-	pF

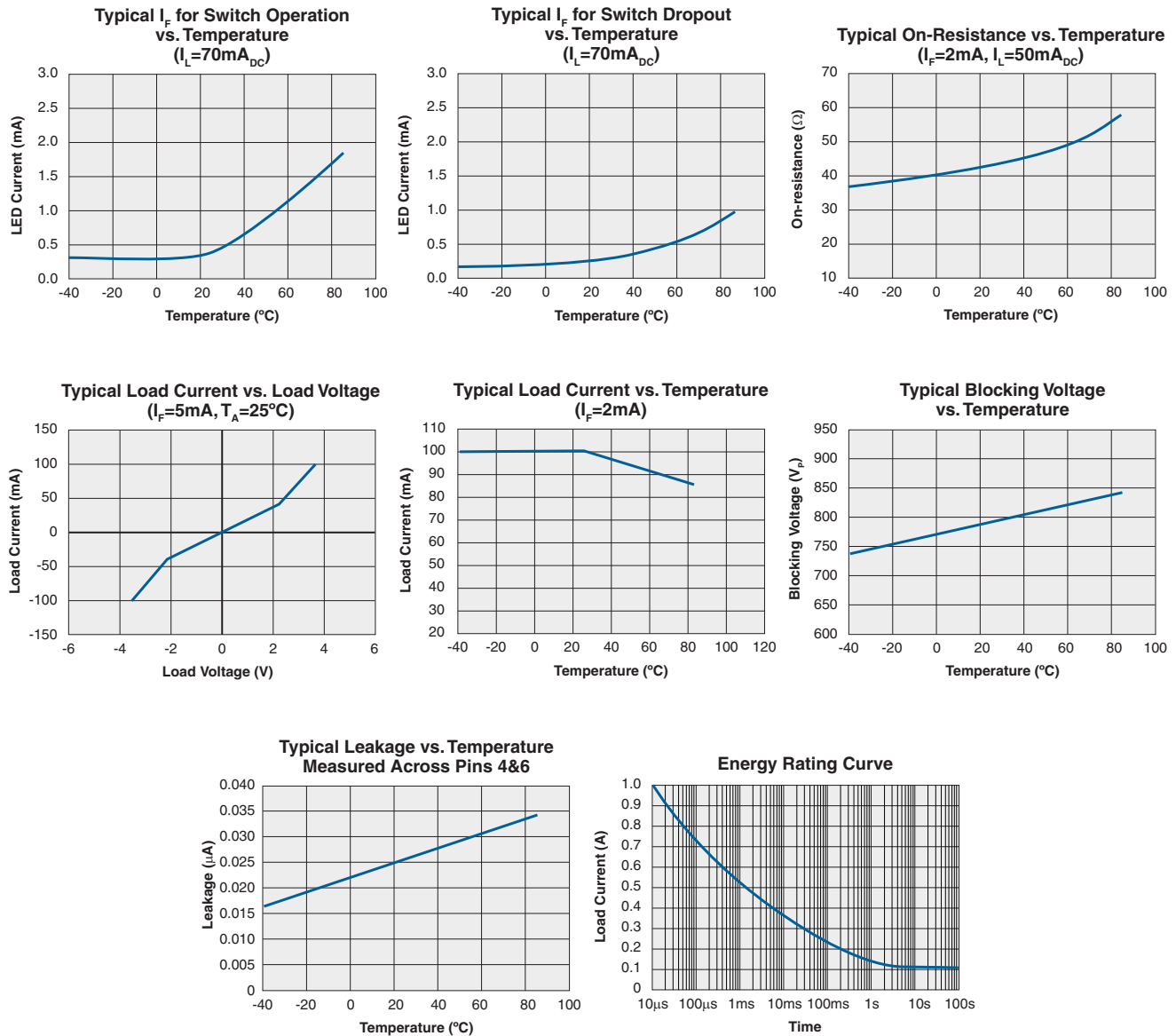
¹ Measurement taken within 1 second of on-time.

PERFORMANCE DATA*



*The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.

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Manufacturing Information

Moisture Sensitivity



All plastic encapsulated semiconductor packages are susceptible to moisture ingress. Clare classified all of its plastic encapsulated devices for moisture sensitivity according to the latest version of the joint industry standard, **IPC/JEDEC J-STD-020**, in force at the time of product evaluation. We test all of our products to the maximum conditions set forth in the standard, and guarantee proper operation of our devices when handled according to the limitations and information in that standard as well as to any limitations set forth in the information or standards referenced below.

Failure to adhere to the warnings or limitations as established by the listed specifications could result in reduced product performance, reduction of operable life, and/or reduction of overall reliability.

This product carries a **Moisture Sensitivity Level (MSL) rating** as shown below, and should be handled according to the requirements of the latest version of the joint industry standard **IPC/JEDEC J-STD-033**.

Device	Moisture Sensitivity Level (MSL) Rating
PLA143 / PLA143S	MSL 1

ESD Sensitivity



This product is **ESD Sensitive**, and should be handled according to the industry standard **JESD-625**.

Reflow Profile

This product has a maximum body temperature and time rating as shown below. All other guidelines of **J-STD-020** must be observed.

Device	Maximum Temperature x Time
PLA143 / PLA143S	250°C for 30 seconds

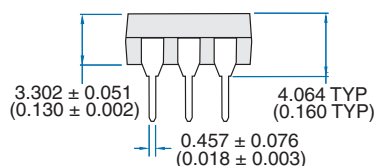
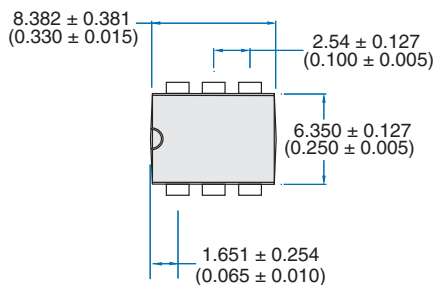
Board Wash

Clare recommends the use of no-clean flux formulations. However, board washing to remove flux residue is acceptable. Since Clare employs the use of silicone coating as an optical waveguide in many of its optically isolated products, the use of a short drying bake could be necessary if a wash is used after solder reflow processes. Chlorine- or Fluorine-based solvents or fluxes should not be used. Cleaning methods that employ ultrasonic energy should not be used.

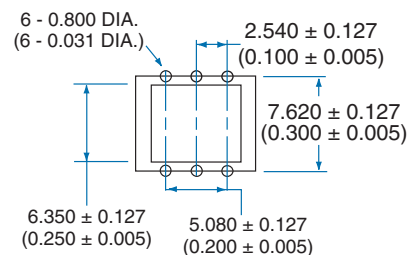


MECHANICAL DIMENSIONS

PLA143

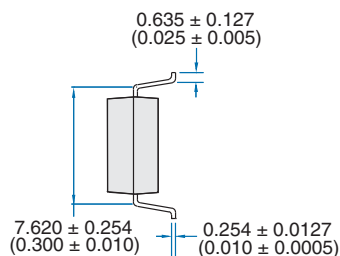
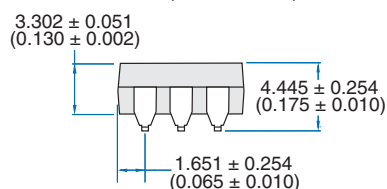
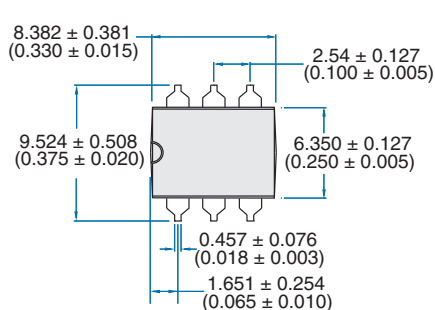


PCB Hole Pattern

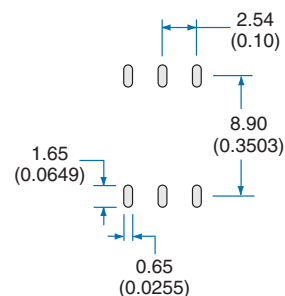


Dimensions
mm
(inches)

PLA143S

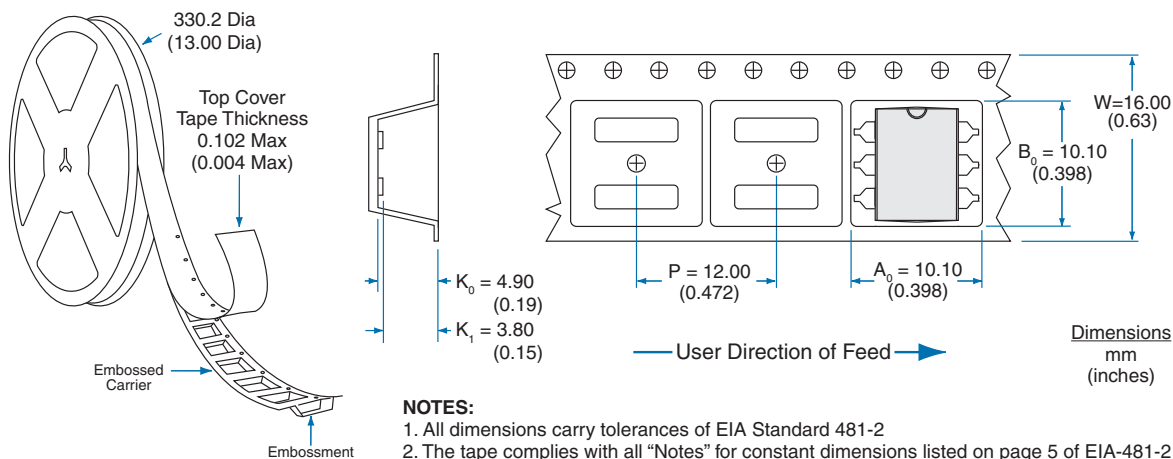


PCB Land Pattern



Dimensions
mm
(inches)

PLA143S Tape & Reel



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